MOSFET – Power, N-Channel, SUPERFET III, Easy Drive

650 V, 19 A, 165 m Ω

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provides superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

Features

- 700 V @ T_J = 150°C
- Typ. R_{DS(on)} = 140 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 35 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 345 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Applications

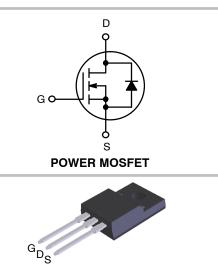
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- Telecom / Server Power Supplies
- Industrial Power Supplies
- Lighting / Charger / Adapter



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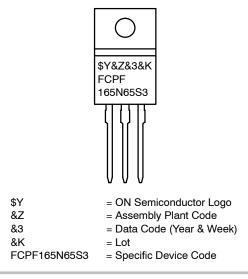
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V _{DSS}	R _{DS(ON)} MAX	I _D MAX
650 V	165 m Ω @ 10 V	19 A



TO-220F CASE 340BF

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit	
V _{DSS}	B Drain to Source Voltage		650	V
V _{GSS}	Gate to Source Voltage	– DC	±30	V
		– AC (f > 1 Hz)	±30	
ID	Drain Current	– Continuous (T _C = 25°C)	19*	А
		– Continuous (T _C = 100°C)	12.3*	
I _{DM}	Drain Current - Pulsed (Note 1)		47.5*	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		87	mJ
I _{AS}	Avalanche Current (Note 2)		2.7	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		0.35	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
PD	Power Dissipation	(T _C = 25°C)	35	W
		- Derate Above 25°C	0.28	W/°C
TJ, T _{STG}	Operating and Storage Temperature Range		–55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 2.7 \text{ A}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 9.5 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, V_{DD} \le 400 \text{ V}, \text{ starting } T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	
$R_{\theta JC}$	R _{0JC} Thermal Resistance, Junction to Case, Max.		°C/W
$R_{\theta JA}$	R _{0JA} Thermal Resistance, Junction to Ambient, Max.		

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCPF165N65S3L1	FCPF165N65S3	TO-220F	Tube	N/A	N/A	50 Units

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
FF CHARACT	ERISTICS	·		•		
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650			V
		V_{GS} = 0 V, I_{D} = 1 mA, T_{J} = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1 \text{ mA}$, Referenced to 25°C		0.64		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
		$V_{DS} = 520 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		1.39		
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±30 V, V_{DS} = 0 V			±100	nA
N CHARACTE	RISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 0.41$ mA	2.5		4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 9.5 A		140	165	mΩ
9fs	Forward Transconductance	V _{DS} = 20 V, I _D = 9.5 A		12		S
YNAMIC CHA	RACTERISTICS					
Ciss	Input Capacitance	$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1415		pF
C _{oss}	Output Capacitance			35		pF
Coss(eff.)	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		345		pF
C _{oss(er.)}	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		48		pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$		35		nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)		8.3		nC
Q _{gd}	Gate to Drain "Miller" Charge			15		nC
ESR	Equivalent Series Resistance	f = 1 MHz		4.6		Ω
WITCHING CH	IARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$		18		ns
t _r	Turn-On Rise Time	R _g = 4.7 Ω (Note 4)		21	1	ns
t _{d(off)}	Turn-Off Delay Time	1		55		ns
t _f	Turn-Off Fall Time	1		16	1	ns
OURCE-DRAII	N DIODE CHARACTERISTICS	-	•	-	-	-
۱ _S	Maximum Continuous Source to Drain	Diode Forward Current			19	Α
I _{SM}	Maximum Pulsed Source to Drain Diode	e Forward Current			47.5	Α
			1	1	1.0	<u>، ر</u>

'8					10	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current				47.5	А
V_{SD}	Source to Drain Diode Forward Voltage $V_{GS} = 0 V$, $I_{SD} = 9.5 A$				1.2	V
t _{rr}	Reverse Recovery Time	$V_{DD} = 400 \text{ V}, I_{SD} = 9.5 \text{ A},$		323		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs		5.2		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

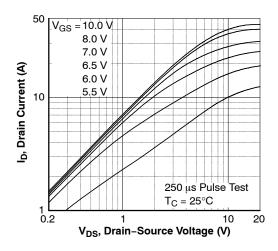
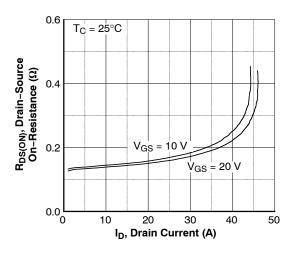
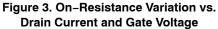


Figure 1. On-Region Characteristics





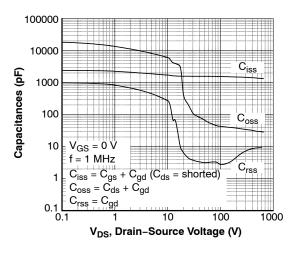


Figure 5. Capacitance Characteristics

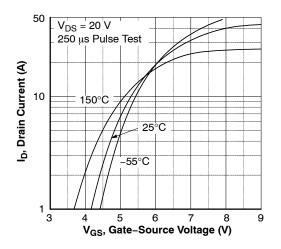
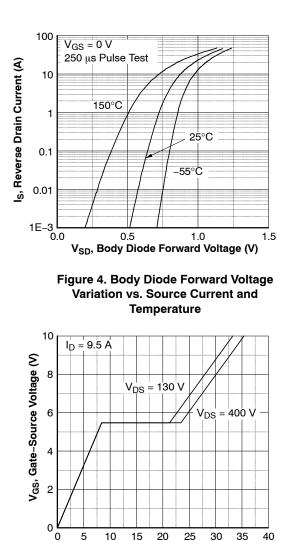
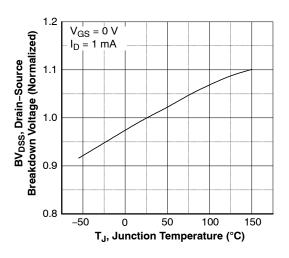


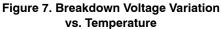
Figure 2. Transfer Characteristics





TYPICAL PERFORMANCE CHARACTERISTICS (continued)





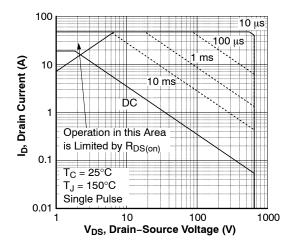


Figure 9. Maximum Safe Operating Area

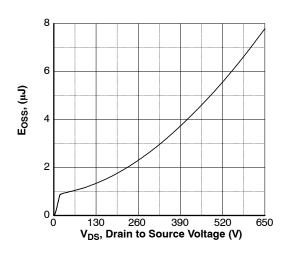


Figure 11. E_{OSS} vs. Drain to Source Voltage

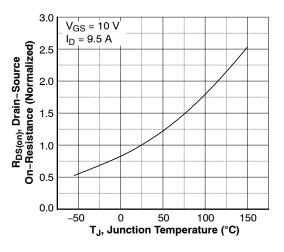


Figure 8. On–Resistance Variation vs. Temperature

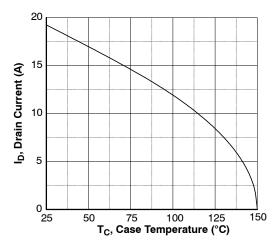


Figure 10. Maximum Drain Current vs. Case Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

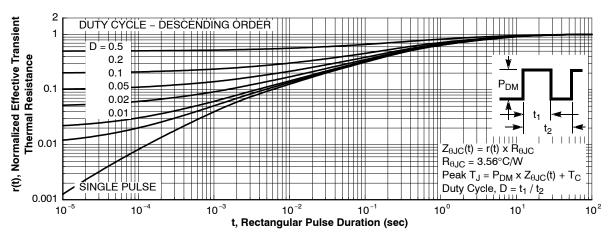


Figure 12. Transient Thermal Response Curve

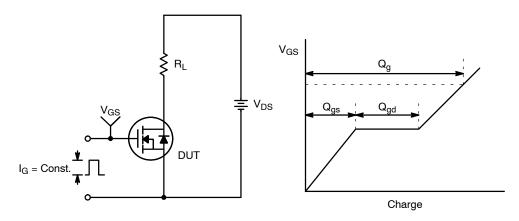


Figure 13. Gate Charge Test Circuit & Waveform

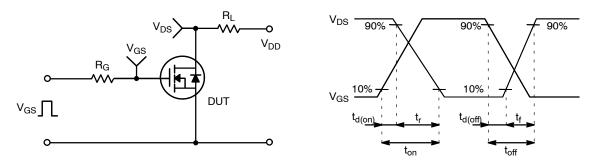


Figure 14. Resistive Switching Test Circuit & Waveforms

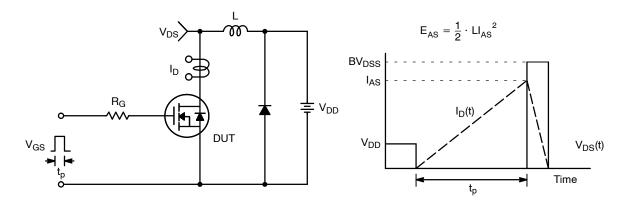


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

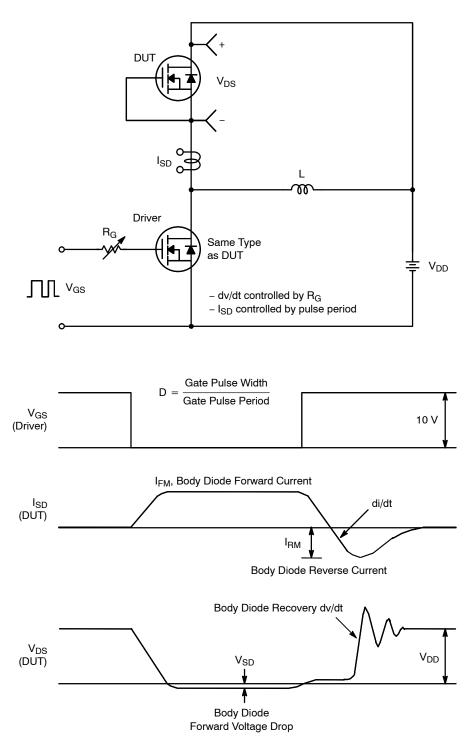


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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TO-220 FULLPAK 3LD CASE 340BF **ISSUE O** DATE 31 AUG 2016 10.30 Α 9.80 2.90 Ø3.40 3.00 2.50 6.60 6.20 3.00 ++2.60 B 19.00 1 X 45° <u>B</u> 15.70 15.00 3.30 B 3 1 2.70 (2.14) 1.20 0.90(2X) 2.30 10.70 10.30 B 0.60 0.40 0.90 (3X) 0.50 1.20 $\oplus 0.50$ M Α NOTES: 2.74 (2X) 2.34 A. EXCEPT WHERE NOTED CONFORMS TO EIAJ SC91A. DOES NOT COMPLY EIAJ STD. VALUE. C. ALL DIMENSIONS ARE IN MILLIMETERS. D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS. E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009. <u>mn mm</u> 4.60 ПП 4.30

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